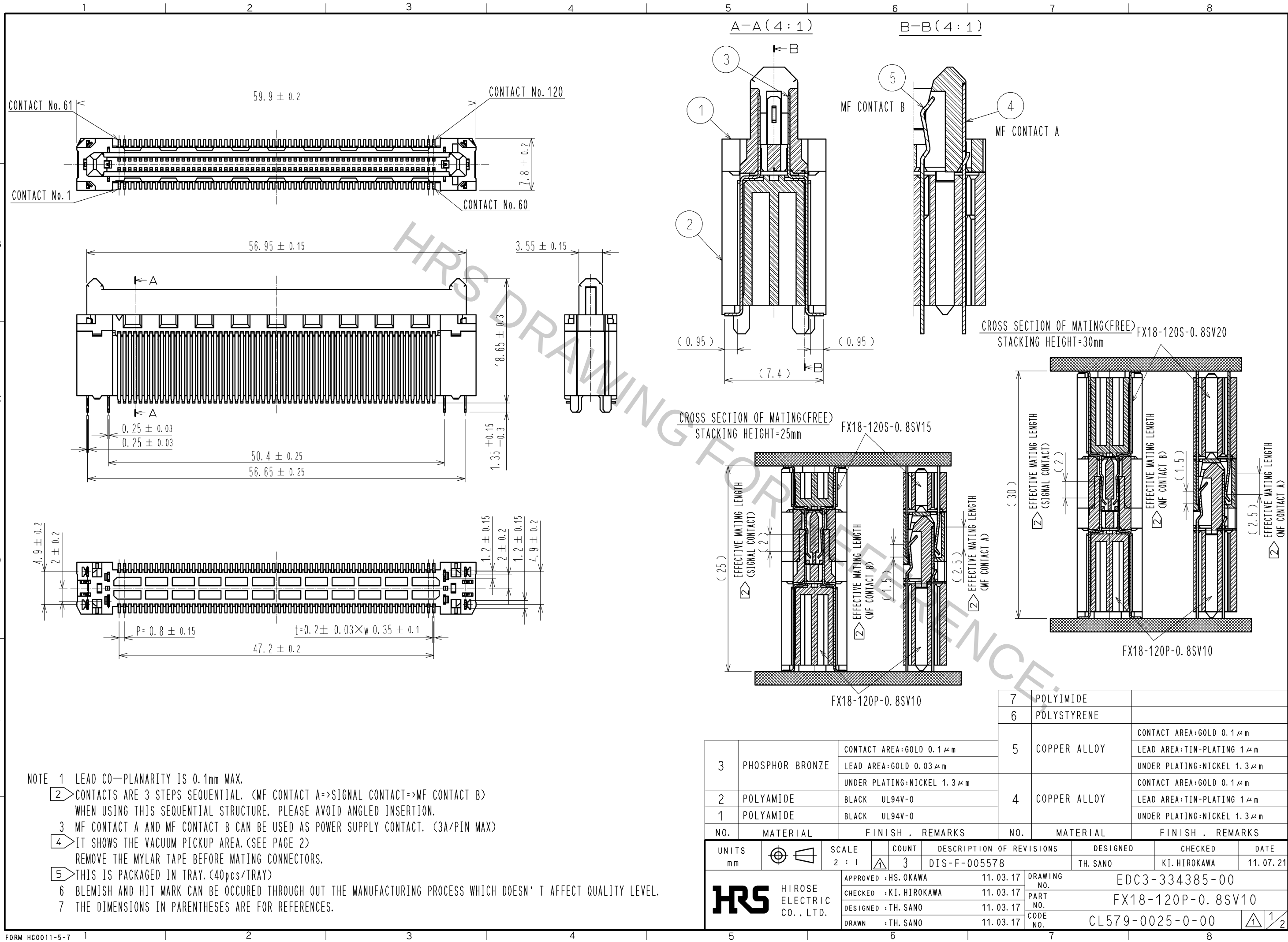




NOTE 1 LEAD CO-PLANARITY IS 0.1mm MAX.

2) CONTACTS ARE 3 STEPS SEQUENTIAL. (MF CONTACT A=>SIGNAL CONTACT=>MF CONTACT B)
WHEN USING THIS SEQUENTIAL STRUCTURE, PLEASE AVOID ANGLED INSERTION.

3 MF CONTACT A AND MF CONTACT B CAN BE USED AS POWER SUPPLY CONTACT. (3A/PIN MAX)

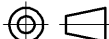
4 IT SHOWS THE VACUUM PICKUP AREA. (SEE PAGE 2)

REMOVE THE MYLAR TAPE BEFORE MATING CONNECTORS.

5 THIS IS PACKAGED IN TRAY. (40pcs/TRAY)

6 BLEMISH AND HIT MARK CAN BE OCCURED THROUGH OUT THE MANUFACTURING PROCESS WHICH DOESN' T AFFECT QUALITY LEVEL.

7 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCES.

3	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm			5	COPPER ALLOY	LEAD AREA:TIN-PLATING 1 μm							
		LEAD AREA:GOLD 0.03 μm					UNDER PLATING:NICKEL 1.3 μm							
		UNDER PLATING:NICKEL 1.3 μm												
2	POLYAMIDE	BLACK UL94V-0			4	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm							
1	POLYAMIDE	BLACK UL94V-0					LEAD AREA:TIN-PLATING 1 μm							
							UNDER PLATING:NICKEL 1.3 μm							
NO.		MATERIAL		FINISH , REMARKS		NO.		MATERIAL		FINISH , REMARKS				
UNITS mm				SCALE 2 : 1		COUNT 3	DESCRIPTION OF REVISIONS DIS-F-005578		DESIGNED TH. SANO		CHECKED KI. HIROKAWA		DATE 11. 07. 21	
 HIROSE ELECTRIC CO., LTD.				APPROVED : HS. OKAWA			11. 03. 17		DRAWING NO.		EDC3-334385-00			
				CHECKED : KI. HIROKAWA			11. 03. 17		PART NO.		FX18-120P-0.8SV10			
				DESIGNED : TH. SANO			11. 03. 17		CODE NO.		CL579-0025-0-00			
				DRAWN : TH. SANO			11. 03. 17				 			

